

New Technologies for Space Projects: Gallium Nitride (GaN) Power Switching Transistors & Assembly- and Test House (ATH)

The 28th Microelectronics Workshop
G. Joormann, DLR (German Aerospace Center)



Knowledge for Tomorrow

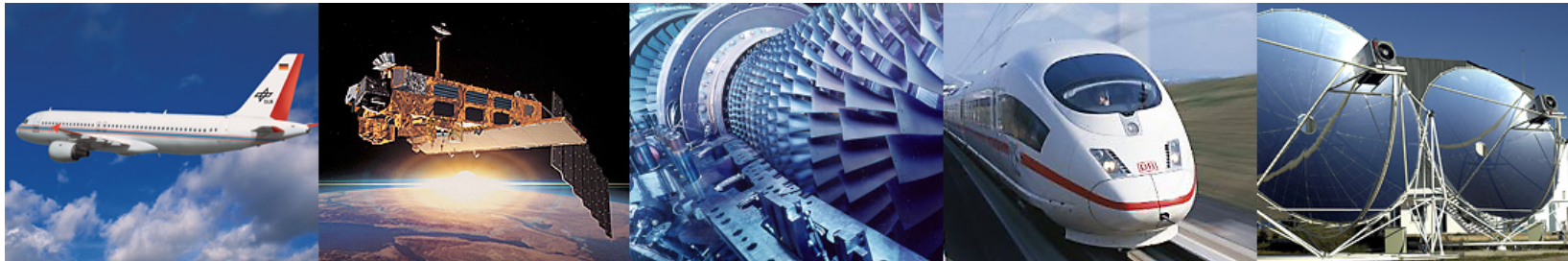
Agenda

- Introduction
 - DLR
 - EEE-parts Section
- GaN Power Switching Transistors
 - Initial situation
 - Status of running activity
 - Outlook
- Assembly- and Test House
 - Initial situation
 - Status
 - Outlook



Introduction DLR German Aerospace Center

- Research Institution
- Space Agency
- Project Management Agency



Research Areas:

Aeronautics, Space Research and Technology, Transport, Energy,
Defence and Security, Space Administration, Project Management Agency

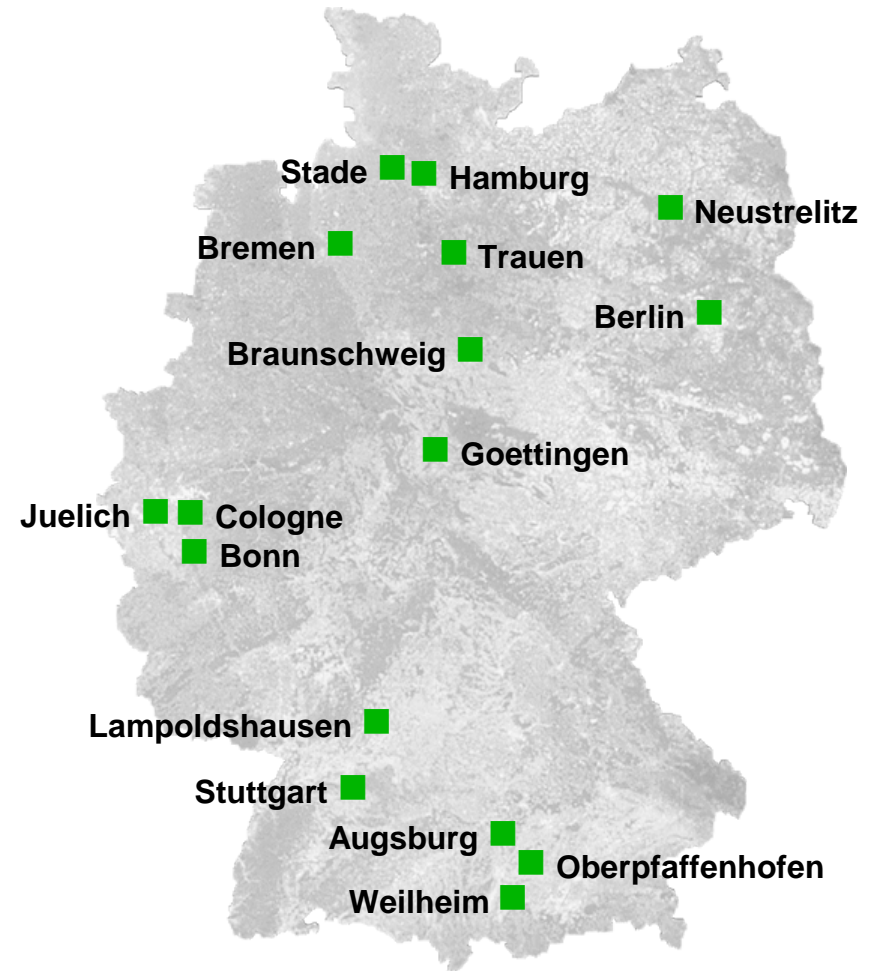


Introduction DLR

Locations and employees

Approx. 8000 employees across
52 institutes and facilities at
■ 16 sites.

Offices in Brussels, Paris,
Tokyo and Washington.



Introduction DLR

Tasks and Responsibilities of DLR EEE-parts Team

Alignment of National Technology Development and Qualification Program for EEE-Parts for Space Applications

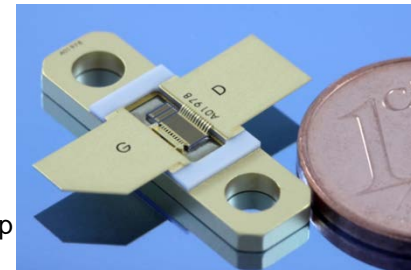
- Investigation of new technologies for usage in space
- Initiation and support of EEE –part qualifications of existing and new technologies (approx. 10 projects simultaneously)
- Coordination of national EEE –part activities (DLR Parts Conference, external team site)
- Identification and prioritization of EEE –parts demand with respect to the
 - Availability of "strategic parts" in the context of national participation in ESA's European Components Initiative (ECI)
 - European harmonization of EEE –part activities
 - Strengthening Germany's technological competitiveness
- Member of the European Space Components Coordination (ESCC):
 - Representatives of the National Space Agency and the national interests of the space industry in the ESCC bodies
 - National Executive for ESCC qualifications and audits



GaN Power Switching Transistors

Initial Situation

- Initial Situation:
 - RF Power Amplifiers are Key Components for Satellite Communication
 - Power Switching Transistors are required for their power supply
 - Actually no space qualified GaN Power Switching Transistors are available
 - GaN shows advantages compared to Silicon
 - Efficiency
 - On-resistance
 - Breakdown voltage
- DLR project with Ferdinand-Braun-Institute (FBH) 2007-2012 :
 - Goal: Development of radhard 100V GaN Switching Transistor
 - Results: Development of 1000V Serial Transistor and 250V and 250V Switching Transistors, threshold voltage $>1V$ and Flip Chip assembly with low thermal resistance.
 - Problems: High dynamic on-resistance and leakage current
 - Conclusion: Follow-up project



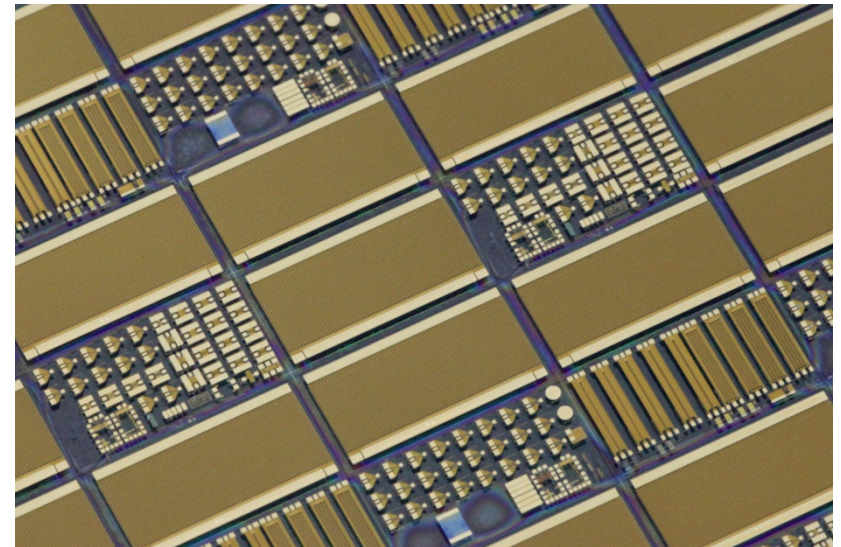
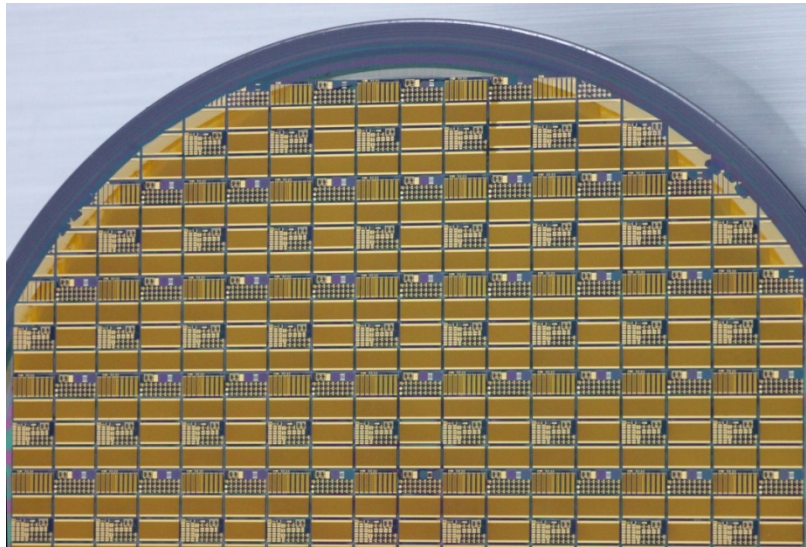
100 m Ω GaN Normally-off Transistor Chip
in a ribbon bonded Microwave Package

GaN Power Switching Transistors

Status of running activity

- Facts:

- Activity running 03/3015 – summer 2016,
- Project is based on experiences and results of previous project
- Risk assessment preparing decision for subsequent space evaluation
- Prime: Ferdinand Braun Institut, FBH (Berlin)
- Subcontractors: Fraunhofer IAF (Freiburg) and Infineon (Munich)



Processed GaN normally-off switching transistors 65 mOhm, GaN on Si Technology



GaN Power Switching Transistors

Status of running activity

- Status:
 - Work packages allocated
 - Radiation tests conditions defined
 - Development and manufacturing of samples done and test fixtures
 - First functional tests running at IAF and FBH
 - Start of radiation tests soon
- Outlook:
 - To analyze in detail the impact of radiation tests on several different GaN epitaxy structures dependent on Si/SiC substrates
 - Space evaluation & qualification according to ESCC



65 mOhm GaN normally-off Chip



Hybrid integrated semi-bridge



100 A GaN normally-off chip for flip-chip assembly



Assembly- and Test House Initial Situation

- More semiconductor manufacturers focus on commercial mass market ☹️
- Those who target the space market are mostly located in the US ☹️
 - ITAR regulation ☹️
- Many non-US semiconductor manufacturers are able to deliver space suitable chips 😊 but...
- Only few manufacturers are capable to assemble into space suitable packages and to run the tests necessary for space applications ☹️

- Conclusion: Growing demand for one centralized institution responsible for:
 - Procurement of chips and packages
 - Assembly of chips into space suitable packages
 - Implementation of space qualification tests
 - Sale

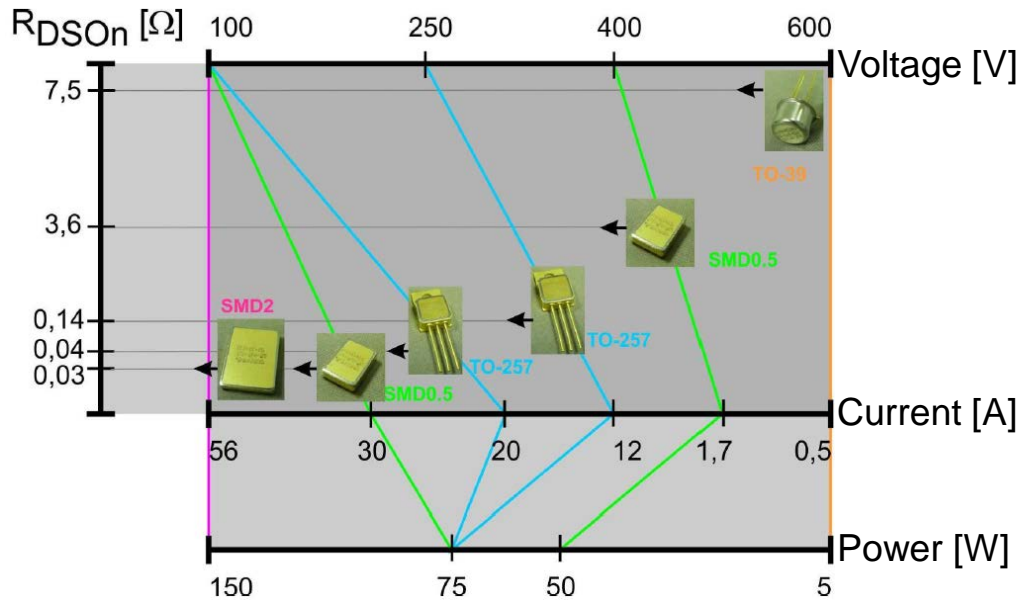
- → Reaction: DLR funded project for establishing an ATH in Germany/Europe



Assembly- and Test House Status

- DLR project Assembly- and Test House (ATH) successfully completed in 2014
- First Sensor Lewicki GmbH certified as ATH for the domain Power MOSFETs

• Domain overview



- Packages inside domain: SMD-2, SMD-0.5, TO-257 & TO-39

Bescheinigung Nr. 02 a

Hiermit wird bestätigt, dass die Firma

First Sensor Lewicki GmbH

im Rahmen des Vertrages mit dem Förderkennzeichen 50 PS 0606 die Fähigkeiten als Assembly- und Test-House für die Domäne Power MOSFETs gemäß der unten angegebenen DLR Spezifikationen erfolgreich nachgewiesen hat.

DLR-RF-PS-STD-006, Iss. 1, Generic Spec.
DLR-RF-PS-STD-013, Iss. 2, Detail Spec. (SMD05)
DLR-RF-PS-STD-014, Iss. 2, Detail Spec. (TO-39)
DLR-RF-PS-STD-016, Iss. 2, Detail Spec. (TO-257/SMD05/SMD2)
DLR-RF-PS-STD-019, Iss. 2, Detail Spec. (TO-257)

Diese Bescheinigung ist gültig bis Dezember 2016.

Köln, 23.07.2015


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Qualitätsmanagement-Beauftragte
des DLR e.V.

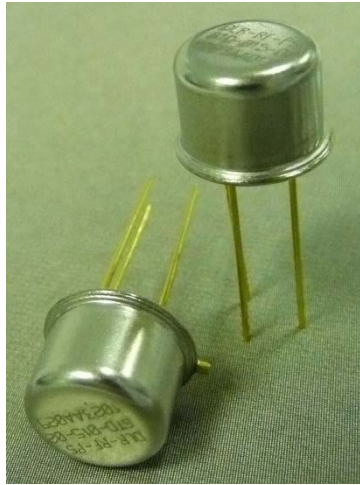

 i.A. Guido Joormann
Gruppenleiter EEE Bauteile
Qualitäts- und Produktsicherung



Deutsches Zentrum
für Luft- und Raumfahrt



Assembly- and Test House Outlook



L6002 in TO-39 acc. to
DLR-RF-PS-STD-014-01



L1056 in TO-257 acc. to
DLR-RF-PS-STD-016-01



L1056 in SMD-2 and SMD-0.5 acc. to
DLR-RF-PS-STD-016-03 and DLR-RF-PS-STD-016-02

... ?

- Outlook:

- Domain extension(s) shall enlarge the range of ATH-qualified parts
- Survey to determine the need for domain extension ongoing



Thank you for your attention!

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and

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